



 Cite this: *RSC Adv.*, 2020, **10**, 18000

Design of a debinding process for polymetallic material green parts fabricated *via* metal paste injection 3D printing with dual nozzles

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Debinding is one of the most critical processes in metal paste injection 3D printing technology (MPI). In order to design the optimal debinding parameters, the debinding temperature, debinding time and heating rate were discussed from the perspective of dynamics. The results showed that there was a peak in liquid phase mass transfer during debinding, exhibiting the characteristics of migration with debinding temperatures. For gas phase mass transfer, when the temperature was 300 °C, the thermal debinding diffusion coefficient was the largest ($9.7 \times 10^{-5} \text{ cm}^2 \text{ s}^{-1}$) and the corresponding debinding time was 3.5 h. By analyzing the activation energy of the debinding reaction, when the heating rate was $10 \text{ }^\circ\text{C min}^{-1}$, the activation energy required for the thermal debinding reaction was the smallest. Combined with the sintering process, the interwoven structural parts of the copper and cupronickel components were finally obtained. The average hardness of the polymetallic parts was 78.8 HV, and the density was 8.1 g cm^{-3} .

Received 18th September 2019

Accepted 20th December 2019

DOI: 10.1039/c9ra07550j

rsc.li/rsc-advances

1. Introduction

Metal paste injection 3D printing technology (MPI) is a new type of metal 3D printing technology.^{1,2} It uses the material deposition principle for forming 3D shapes layer-by-layer, similar to Fused Deposition Modeling (FDM).^{3,4} Compared with selective laser melting (SLM), electron beam melting (EBM) and laser micro sintering (LMS) technology,^{5–7} MPI has the outstanding advantages of low cost and a wide application range of materials, and also avoids micro-crack defects in laser melting technology,⁸ showing a broad development prospect in the field of micro-miniature metal parts manufacturing.⁹ In this work, we improved the laboratory-made MPI equipment that could be used to print polymetallic materials with dual nozzles, which is difficult to achieve *via* other metal 3D printing technologies.

To provide the fluidity of the printed material system, the binder should be utilized in the MPI process. Paraffin wax is a kind of common adhesive which could adjust the viscosity by controlling its content, make the MPI process possible to print metal materials, ceramic materials, polymer materials, composite printing¹⁰ and polymetallic materials. The green body printed by the MPI process is subjected to a debinding and sintering stage.

The binder is a component of the green part supporting the metal powder, so it must be completely removed from the body to obtain a sintered body with a dense structure, no defects, and excellent properties. The residue of the binder will destroy the

perfect sintering of the metal powder particles and the formation of sintered neck. The thermal debinding method is easy to control compared with other debinding process^{11,12} (solvent debinding, extraction debinding), and the removal of the binder can be smoothly completed by thermal debinding. In addition, the thermal debinding and sintering integration of the MPI process can be realized.^{13,14}

In order to explore basic scientific issues to develop the optimal debinding process, the mass transfer mechanism and dynamics had been investigated quantitatively in previous publication.¹⁵ In this work, the metal paste were separately prepared by using copper powders and cupronickel powders. The copper paste and cupronickel paste were alternately injected layer by layer through the double nozzles to get polymetallic material green parts, after which the debinding temperature, debinding time and heating rate were discussed from the perspective of kinetic analysis. Therefore, it provided a theoretical basis for optimizing the thermal debinding process.

2. Experiment

The copper powders (Avg. $1.5 \text{ }\mu\text{m}$, purity > 99.5%) and cupronickel powders (Avg. $1.5 \text{ }\mu\text{m}$, purity > 99.5%) were utilized to prepare copper paste and cupronickel paste according to the mass ratio ($m_1 : m_2 = 10 : 1$) of powder to paraffin wax (0.9 g cm^{-3}), respectively.

A laboratory based equipment was built, composed of the 3D printer and syringe with double nozzles (0.4 mm in diameter). The copper paste and cupronickel paste were prepared with a preparation device that agitated and heated up the mixed

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Generation of computer code

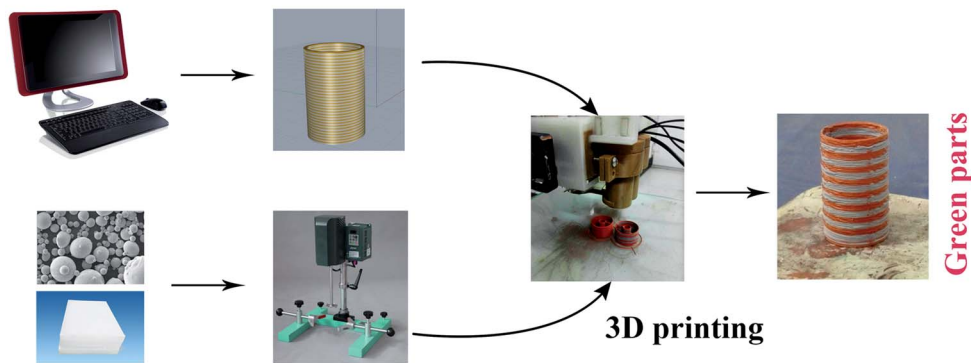


Fig. 1 The printing process, printing equipment and the printed green part.

materials. The viscometer (LV DV-II+Pro, America) was utilized to measure the viscosity of the copper paste. The rotation speed was between 18 and 36 rpm and the temperature was set with the change of temperature (65 °C, 70 °C, 75 °C, 80 °C and 85 °C), after which the copper paste and cupronickel paste were printed alternately according to software (Cura 2.1.3). The printing parameters can be described as the drive gear diameter of 7.5 mm, the retraction distance of 1.7 mm and the layer height of 0.55 mm. The printing process, printing equipment and the printed green part were summarized in Fig. 1.

After printing process, the green parts were put into the muffle furnace (SX2-5-12, China) under carbon powder embedding to explore the debinding process. Thermogravimetric analysis (TG-DSC) was tested under N₂ atmosphere ramping up from 20 to 1050 °C at a heating rate of 5 °C min⁻¹. The microstructures of samples were observed by a Field Emission Scanning Electron Microscope (FE-SEM, SU8010,

Hitachi, Japan). Besides, the debinding ratio, shrinkage and burnout ratio of samples were also investigated. Here, debinding ratio refers to the ratio of removed binder to total binder. The density was measured by a drainage method and the hardness was tested by a digital micro-hardness tester (HVS-1000B).

3. Results and discussion

In order to optimize the debinding process, factors such as viscosity, debinding temperature, debinding time and heating rate were analyzed from the perspective of dynamics.

3.1. Determination of viscosity

When the material ratio is determined, the viscosity of the material system mainly depends on the mixing temperature. Generally, the higher the paste mixing temperature, the lower

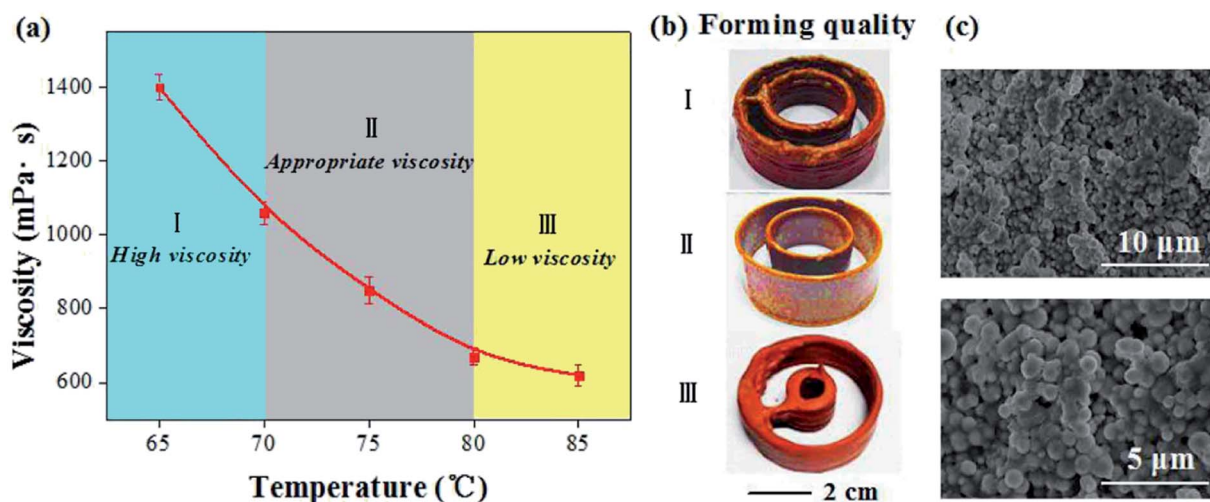


Fig. 2 Effect of viscosity on copper paste printing test: (a) relationship between paste viscosity and temperature; (b) printing quality at different viscosities; (c) SEM images of samples in suitable viscosity range.



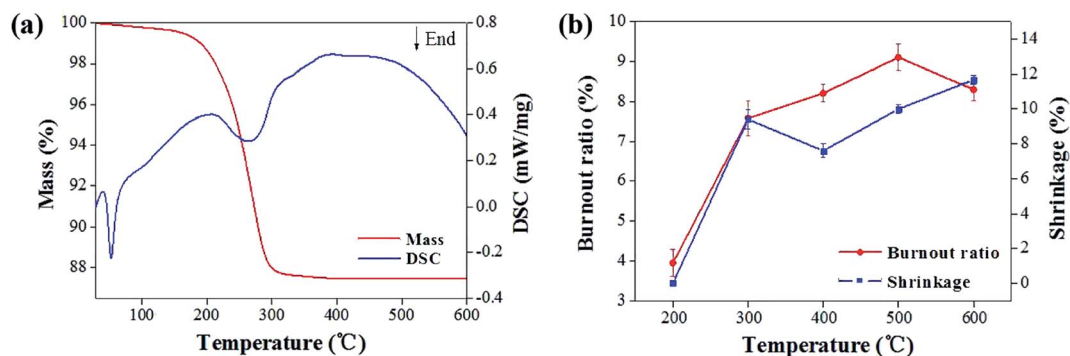


Fig. 3 Thermal analysis of sample: (a) TG-DTA curve of the sample; (b) shrinkage ratio and mass loss ratio curve.

the viscosity of the material system will be.^{16,17} During the printing process, the viscosity of the paste needs to be controlled within a suitable range. If the viscosity is too high, the resistance of the paste is large, which is not favorable for forming; but if the viscosity is too small, the injection paste cannot be solidified well, resulting in failure to form the three-dimensional (3D) structure.

Taking copper paste as an example, Fig. 2 showed the relationship between mixing temperature, viscosity and printing quality. When the mixing temperature was raised from 65 °C to 85 °C (Fig. 2a), the viscosity of the paste showed a downward trend. In order to further clarify the suitable mixing temperature, the printing quality at 65–70 °C (1100–1385 mPa s), 70–80 °C (700–1100 mPa s) and 80–85 °C (650–700 mPa s) were tested. It can be found that the print quality corresponding to the interval of 70–80 °C (860 mPa s) was better (Fig. 2b), which was the suitable viscosity interval. By characterizing the microstructure of the sample printed with the appropriate viscosity interval, uniform copper particles mixed with the binder were exhibited (Fig. 2c).

3.2. Debinding temperature selection strategy

3.2.1 Analysis of debinding ratio. To roughly guide the selection of the debinding temperature, the paste was firstly subjected to thermogravimetric analysis. Since the temperature in the debinding stage was not high which was far less than the melting point of the copper powder and the cupronickel powder, it was only necessary to consider the removal process of the binder. As the temperature was increased to 300 °C, the sample exhibited slightly weight loss, indicating the end of paraffin decomposition. After 400 °C, the sample quality was almost no change (Fig. 3a).

Fig. 3b showed the shrinkage and mass loss ratio curves for the cupronickel paste at different temperatures. It can be seen that the main stage of sample mass loss and shrinkage was also within 400 °C. In order to obtain the optimum debinding temperature, a set of temperature parameters (250 °C, 300 °C, 350 °C, and 400 °C) was designed for comparative analysis. It can be seen that the debinding ratio increased with increasing debinding time and eventually tended to be stable (Fig. 4). Moreover, the higher the debinding temperature, the faster the

debinding rate. When the temperature was higher than 300 °C, the final debinding ratio exceeded 95%, but the debinding ratio at 250 °C for 4 h was still less than 90%.

In the debinding environment of carbon powder embedding, the mass transfer pathway of debinding process mainly includes gas phase mass transfer and liquid phase mass transfer. The dominant role is gas phase mass transfer,^{17–19} so generally using diffusion kinetic equation^{20,21} and diffusion coefficient²² to quantitatively analyze. The liquid phase mass transfer pathway is characterized by liquid phase migration under capillary force, which can be roughly quantified by calculating the difference in debinding ratio between carbon powder embedding and non-carbon powder.

The debinding ratio curves at different temperature under the embedded carbon powder and air environment were illustrated as Fig. 5. The debinding ratio demonstrated a rising trend with time, but the debinding ratio under embedding carbon powder was slightly higher than that in air atmosphere, the difference of which were contributed by the liquid phase migration under capillary forces. It can be found that the higher the temperature, the more the debinding ratio tended to reach a maximum in a short period of time (blue area in the Fig. 5). When the temperature was 300 °C, it took 3.5 h (Fig. 5b). Increasing the temperature to 400 °C, it only took 2.7 h (Fig. 5d).

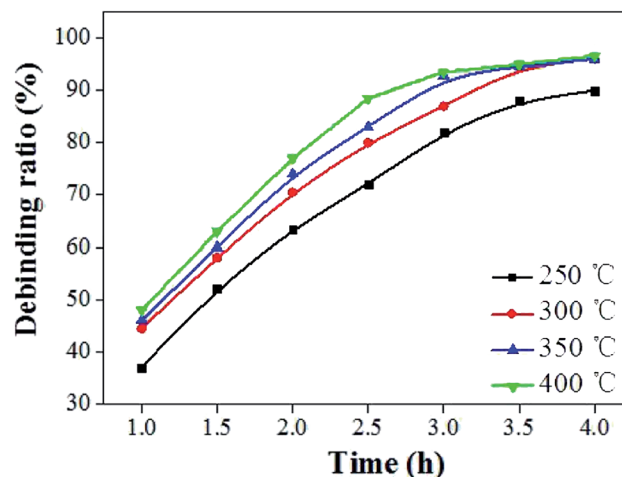


Fig. 4 Debinding ratio curve at different temperatures.



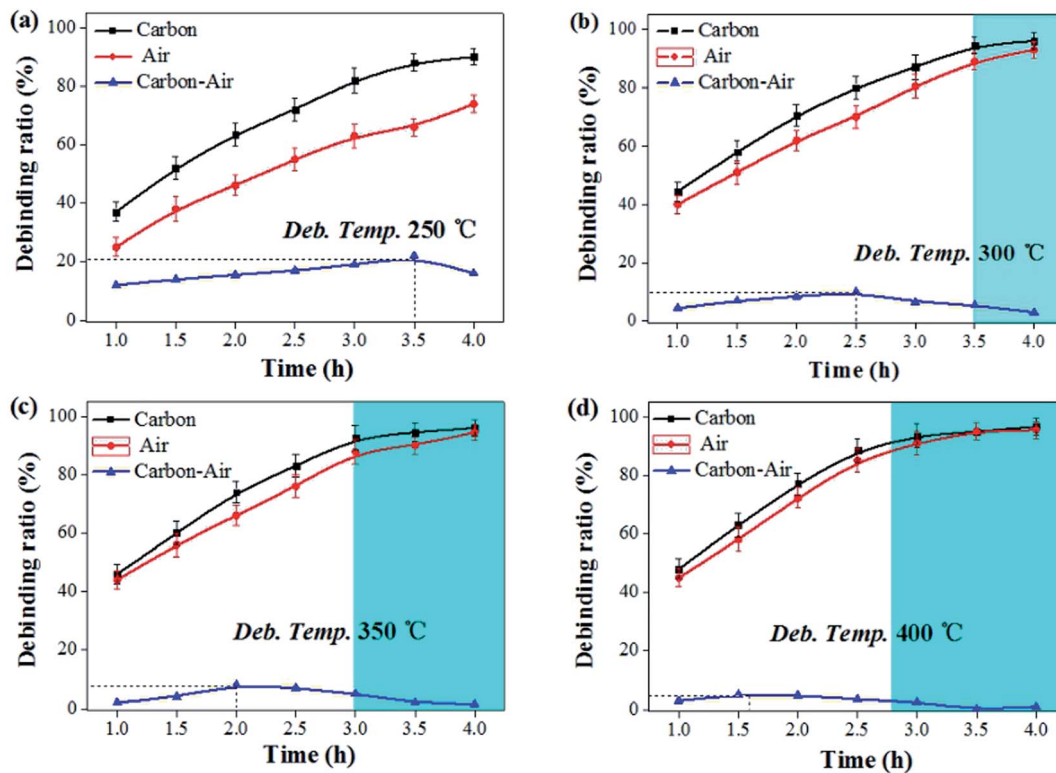


Fig. 5 The debinding ratio curves at different temperature under the embedded carbon powder and air environment: (a) 250 °C; (b) 300 °C; (c) 350 °C; (d) 400 °C.

3.2.2 Liquid mass transfer. The blue curve in Fig. 5 represented the liquid phase mass transfer level at different debinding temperatures. It was confirmed that the gas phase mass transfer played a leading role in the debinding process. Here, we first discussed the role of liquid phase mass transfer at different temperatures. It can be found that the liquid phase mass transfer effect was first increased and then attenuated at each temperature (Fig. 6). This may be due to the fact that in the early stage of debinding, the inside of the sample was filled with a large amount of paraffin, and large-scale pore channels had

not been formed, thus restricting the mass transfer efficiency of the liquid phase. With the increase of debinding time, due to the intensification of physical and chemical changes such as melting, decomposition and volatilization of paraffin, large-scale pore channels were formed inside the sample, which led to the peak of liquid phase mass transfer effect. With the further increase of the debinding time, since the paraffin inside the sample was completely removed, the liquid phase mass transfer and the gas phase mass transfer were both not obvious.

The liquid phase mass transfer decreased with increasing temperature (Fig. 6). The peak of liquid phase mass transfer effect shifted to the left of the time axis as the temperature increased, indicating that the higher the temperature, the shorter the time when liquid phase mass transfer worked.

3.2.3 Diffusion coefficient calculation. The diffusion coefficient (d) of gas products could be used as a key indicator of mass transfer process, and the mass transfer process could be described by the diffusion dynamics equation which can be expressed as eqn (1) and (2).^{23–26}

$$\ln \frac{1}{F} = d\pi^2 \frac{t}{\psi^2} + K_1 \quad (1)$$

$$\psi = \frac{V}{S} \quad (2)$$

F : the fraction of remaining low molecular weight binder in the sample; d : diffusion coefficient; t : debinding time; S : surface area; V : volume; K_1 : constant term; ψ : dimension of length. It is clear that $\ln(1/F)$ and t/ψ^2 have a linear relationship and the

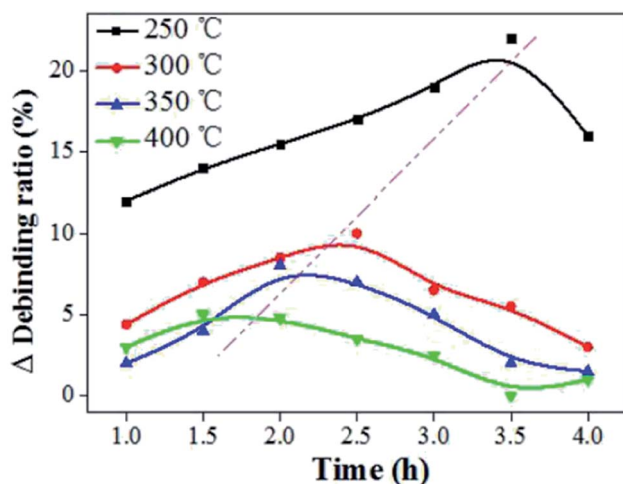


Fig. 6 Liquid mass transfer effect curve.



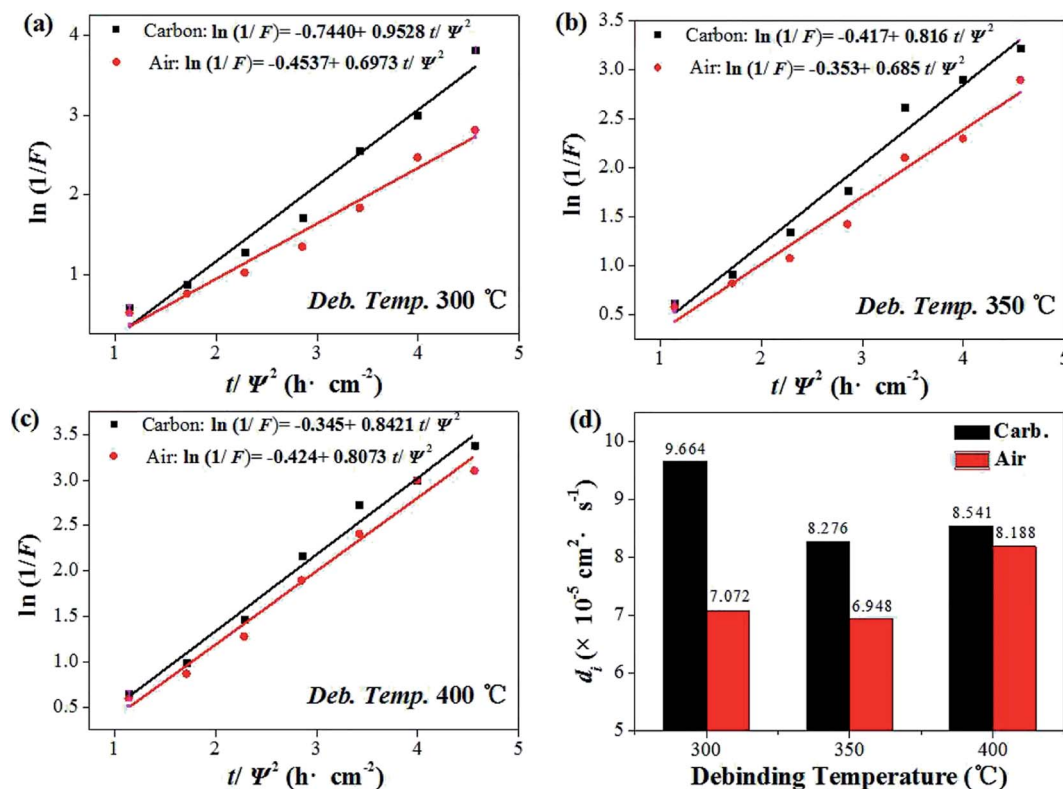


Fig. 7 The calculation of diffusion coefficients at different debinding temperatures: (a) 300 °C; (b) 350 °C; (c) 400 °C; (d) statistics of diffusion coefficients.

slope depends on the diffusion coefficient. So we made the plot fitting of eqn (1), and the results of fitting were illustrated as Fig. 7a–c. Diffusion coefficient obtained after linear fitting were shown as Fig. 7d. By analyzing Fig. 7d, we found that the diffusion coefficient in the case of carbon powder embedding were higher than that in the air atmosphere at different temperature because of the more interior pores of the sample caused by migration of the liquid phase under the capillary force in the environment of the embedding of the carbon powder. Comparing the thermal debinding diffusion coefficient at different temperatures, it can be seen that when the temperature was 300 °C, the diffusion coefficient was the largest ($9.7 \times 10^{-5} \text{ cm}^2 \text{ s}^{-1}$), and the corresponding diffusion kinetic equation could be summarized as eqn (3).

$$\ln \frac{1}{F} = -0.744 + 0.9528 \frac{t}{\Psi^2} \quad (3)$$

3.3. Selection strategy for heating rate

Activation energy (E) is an also important parameter in debinding dynamics. Coats–Redfern method provided an effective theoretical basis for the calculation of activation energy (E). Based on the kinetics of the non-isothermal thermogravimetric loss curve during debinding of MIM, the dynamics mechanism could be expressed as eqn (4):^{27,28}

$$\ln \frac{G(\alpha)}{T^2} = \ln \frac{AR}{\beta E} - \frac{E}{RT} \quad (4)$$

$RT/E \ll 1$, $1 - 2RT/E \approx 1$. $G(\alpha) = -\ln(1 - \alpha)$, $n = 1$; $G(\alpha) = [1 - (1 - \alpha)^n]/(1 - n)$, $n \neq 1$. n : reaction order; A : pre-exponential factor; R : gas constant, $8.314 \text{ J mol}^{-1} \text{ K}^{-1}$; β : heating rate; E : activation energy; T : thermodynamic temperature; α : conversion rate corresponding to time. The thermogravimetric and weight loss rate curves at different heating rate for the cupronickel paste in this study were shown as Fig. 8a. It can be found that as the heating rate increased, the mass loss curve shifted to the left of the time axis. Because the higher the heating rate, the higher the reaction temperature was and the faster the reaction rate would be in a certain period of time. But due to the degree of reaction was insufficient, the value of quality loss in a short period of time was relatively lower. It can also be seen from Fig. 8 that there is a peak in the weight loss rate curve at different heating rates. From eqn (4), $\ln \frac{G(\alpha)}{T^2}$ and $1/T$ shows a linear relationship, so activation energy (E) can be calculated by the slope and intercept *via* the fitting of them. In this work, it was assumed that the reaction order was 1 ($n = 1$) and then the fitting results were exhibited as Fig. 8b and Table 1. It can be found that Adj. R -square data shows a good linear relationship. The fitting results show that when the heating rate was $10 \text{ }^\circ\text{C min}^{-1}$, the activation energy required for the thermal degreasing reaction was the smallest. The corresponding debinding kinetic equation is eqn (5).

$$\ln \frac{G(\alpha)}{T^2} = -13.74 - \frac{1.458}{T} \quad (5)$$



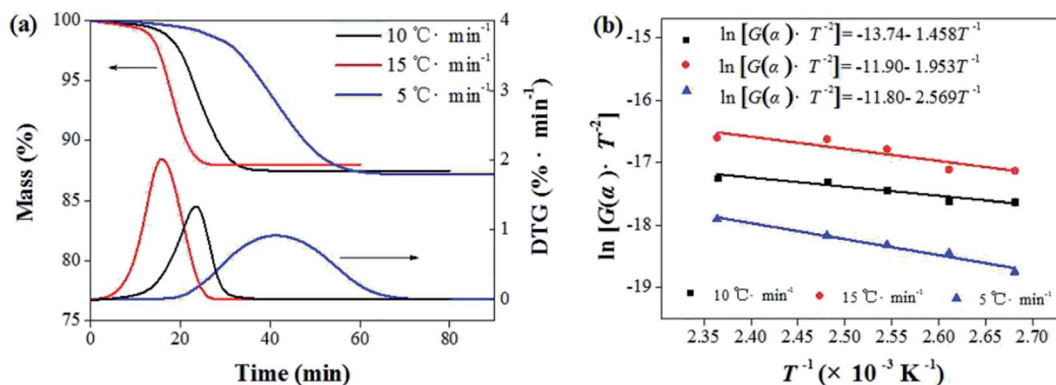


Fig. 8 Calculation of activation energy: (a) the thermogravimetric and weight loss rate curves at different heating rates; (b) the fitting curves between $\ln \frac{G(\alpha)}{T^2}$ and $1/T$.

Table 1 Activation energy of debinding process of cupronickel paste

Heating rate/(°C min ⁻¹)	Activation energy, E /(kJ mol ⁻¹)	Adj. R -square
5	21.36	0.929
10	12.12	0.971
15	16.24	0.800

3.4. Design and analysis of debinding process

Based on the above analysis, the parameters were determined (debinding temperature 300 °C, heating rate 10 °C min⁻¹, debinding time 3.5 h). After the debinding process was

completed, sintering was continued at 950 °C for 2 h, and finally the interwoven structure of copper and cupronickel components was obtained (Fig. 9b). By observing the SEM images (Fig. 9c) of the samples, the evolution of the microstructure in debinding process can be understood. It can be found that the sample has a dense microstructure after the sintering process. The average hardness of sintered parts was 78.8 HV, and the density was 8.1 g cm⁻³.

4. Conclusions

In this work, the debinding temperature, debinding time and heating rate were discussed from the perspective of kinetic analysis. The viscosity test results showed that the optimum

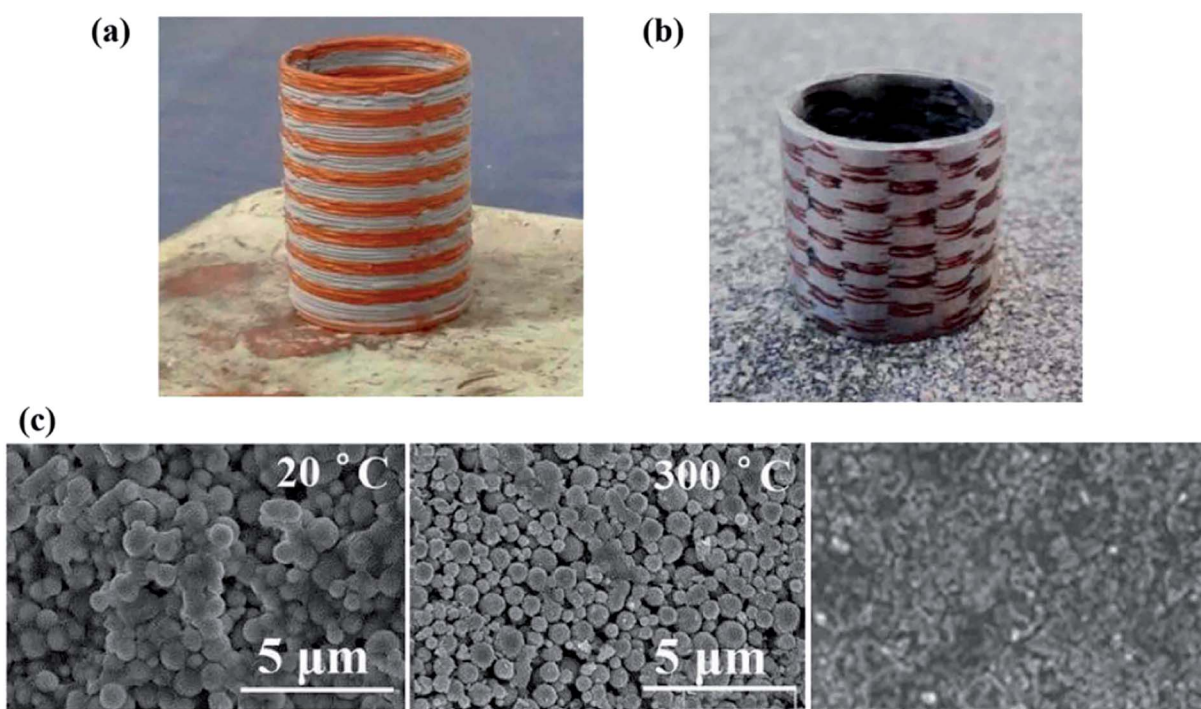


Fig. 9 Formed sample and properties: (a) printed polymetallic material green parts; (b) sintered part; (c) SEM images of samples at different stage.



preparation temperature of the copper paste and cupronickel paste was 70–80 °C. There was a peak in liquid phase mass transfer effect during debinding and exhibited the characteristics of migration with temperatures. For gas phase mass transfer, when the temperature was 300 °C, the thermal debinding diffusion coefficient was the largest ($9.7 \times 10^{-5} \text{ cm}^2 \text{ s}^{-1}$), and the corresponding debinding time was 3.5 h. By analyzing the activation energy of the debinding reaction, when the heating rate was $10 \text{ }^\circ\text{C min}^{-1}$, and the activation energy required for the thermal debinding reaction was the smallest. Combined with the sintering process, the interwoven structure of copper and cupronickel components was finally obtained. The average hardness of sintered parts was 78.8 HV, and the density was 8.1 g cm^{-3} . This study provides an innovative approach to the control mechanism of the MPI debinding process, and confirms the feasibility of MPI forming multi-metal material parts at a low cost.

Conflicts of interest

There are no conflicts to declare.

Acknowledgements

We gratefully acknowledge the financial support by National Natural Science Foundation of China (No. 51675496, No. 51902295 and 51671091), Wuhan City Applied Basic Research Project, China (No. 2017010201010126). This paper is CJHI contribution CJHIWZ-2020001. The authors acknowledge the financial support of a Grant (CJHIXM-S201617) from Center for Jewelry Heritage and Innovation, a Hubei Provincial Key Research Base for Humanity and Social Sciences. The project was also kindly supported by the Fundamental Research Funds for the Central Universities, China University of Geosciences (Wuhan) (No. CUG170677) and Hubei Province Natural Science Foundation grant (No. 2019 CFB264).

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